

OptoPAC, great start at first day of KOSDAQ listing

Seoul, Korea July 20, 2016



OptoPAC has developed Chip Scale Packaging (CSP) solutions for image sensors. Stock price rose 29.95% than opening price, ended price was KRW8,070. It is rose 36.78% than offering price.

OptoPAC was listed on KONEX in October 2014 and delisted in July 2016 for listing on KOSDAQ. KONEX is the market for start-up venture companies and opened on July 2013.

OptoPAC is the company providing the packaging for image sensor which is mainly used in smartphone camera to camera module company. Revenue of last year was KRW 31.7 billion, operating loss was KRW 300 million.

Source: <http://www.businesspost.co.kr/news/articleView.html?idxno=31037>